

ABSTRACT OF THE DISCLOSURE

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5 A front substrate and a rear substrate are laid on
each other with a sealing frit therebetween. The front
substrate, the rear substrate and the sealing frit are
heated in a chamber and impurity gas is exhausted from both
of the substrates by lowering internal pressure of the
chamber. The sealing frit is melted in the chamber by
further heating the front substrate, the rear substrate and
10 the sealing frit. The sealing frit is solidified in the
chamber and sealing up the front substrate and the rear
substrate.
